Docket No.: 4459-079



AF 2871

Soles and Wall

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of

EXPEDITED PROCEDURE

Cheng Chi WANG

RESPONSE UNDER 37 CFR 1.116

,

Confirmation No. 1134

U.S. Patent Application No. 10/084,989

Group Art Unit: 2871

Filed: March 1, 2002

Examiner: T. Duong

For:

THIN FILM TRANSISTOR PANEL

Dear Sir:

Transmitted herewith is an Amendment in the above identified application.

No additional fee is required.

Small entity status of this application has been established.

Also attached: Tables A and B, and Exhibit B

The fee has been calculated as shown below:

	NO. OF CLAIMS	HIGHEST PREVIOUSLY PAID FOR	EXTRA CLAIMS	RATE	FEE
Total Claims	 11	20	0	x \$ 18 =	\$ 0.00
Independent Claims	 4	4	0	x \$ 84 =	\$ 0.00
		If multiple claims newly presented, add \$280.00 Fee for extension of time			n/a
					n/a
			r	TOTAL FEE DUE	\$ 0.00

1 1	A credit card authorization form in the amount of	f	is attached
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The Commissioner is hereby authorized to charge payment of any fees associated with this communication or credit any overpayment, to Deposit Account No. <u>07-1337</u>, including any filing fees under 37 CFR 1.16 for presentation of extra claims and any patent application processing fees under 37 CFR 1.17.

Respectfully submitted,

LOWE HAUPTMAN GILMAN & BERNER, LLP

Benjamin J. Hauptman Registration No.: 29,310

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